



PERMLT.019A

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : John Popovich, et al.

Appl. No. : 09/693,548

Filed : October 19, 2000

For : MOUNTING
ARRANGEMENT FOR LIGHT
EMITTING DIODES

Examiner : Laura K. Tso

) Group Art Unit 2875

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Glen L. Nuttall, Reg. No. 46,188

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OFFICE ACTION RESPONSE

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

In response to the Office Action mailed April 24, 2002, Applicants respectfully submit the following amendments and comments in connection with the above-captioned application.

IN THE CLAIMS:

Please amend the claims to read as follows:

1. (Amended) A light emitting diode (LED) module for mounting on a heat conducting surface that is substantially larger than the module, the module comprising:
- a plurality of LED packages, each package comprising an LED and at least one lead; and
 - a circuit board, the circuit board comprising:
 - a thin dielectric sheet;
 - a plurality of electrically-conductive contacts on a first side of the dielectric sheet, each of said plurality of contacts being configured to mount a lead of an LED package such that said plurality of LEDs is series connected; and

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